## AVX Multilayer Ceramic Transient Voltage Suppressors TVS Protection and EMI Attenuation in a Single Chip

## GENERAL DESCRIPTION

AVX has combined the best electrical characteristics of its TransGuard® Transient Voltage Suppressors (TVS) and its Feedthru Capacitors into a single chip for state-of-the-art overvoltage circuit protection and EMI reduction over a broad range of frequencies. This unique combination of multilayer ceramic construction in a feedthru configuration gives the circuit designer a single 0805 chip that responds to transient events faster than any TVS device on the market today, and provides significant EMI attenuation when in the off-state.

Automotive TransFeed® is designed for automotive applications and are AEC-Q 200 qualified.

The reduction in parallel inductance, typical of the feedthru chip construction when compared to the construction of standard TVS or ceramic capacitor chips, gives the TransFeed® product two very important electrical advantages: (1) faster "turn-on" time. Calculated response times of <200 pSec are not unusual with this device, and measured response times range from 200 - 250 pSec. The TransFeed® "turn-on" characteristic is less than half that of an equivalent TransGuard<sup>®</sup> part – and TransGuards<sup>®</sup> clamp transient voltages faster than any other bipolar TVS solution such as diodes; (2) the second electrical advantage of lower parallel inductance, coupled with optimal series inductance, is the enhanced attenuation characteristics of the TransFeed® product. Not only is there significantly greater attenuation at a higher self-resonance frequency, but the roll-off characteristic becomes much flatter, resulting in EMI filtering over a much broader frequency spectrum. Typical applications include filtering/protection on Microcontroller I/O Lines, Interface I/O Lines, Power Line Conditioning and Power Regulation.

## **TYPICAL APPLICATIONS**

- Drive by Wire
- **Dimming Mirror Circuit**
- Filtering/protection on Microcontroller I/O lines
- Filtering/protection on Interface I/O lines
- Power Line Conditioning
- Power Regulation
- · LCD Dashboard driver

Where designers are concerned with both transient voltage protection and EMI attenuation, either due to the electrical performance of their circuits or due to required compliance to specific EMC regulations, the TransFeed product is an ideal choice.

# Schematic Diagram Electrical Model OUT С RON Lр

#### **GENERAL CHARACTERISTICS**

- Operting Teperature: -55°C to +125°C
- · Working Voltage: 5.6Vdc 26Vdc
  - Case Size: 0805
  - Energy Rating: 0.05 0.3J
  - · Current: 20 120A
  - Max Feedthru Current: 0.5 1A

#### FEATURES

- Bi-directional TVS
- Narrow band, high attenuation filter
- EMI Filtering over broader frequency range
- Fastest Response Time to ESD Strikes
- · AEC-Q 200 Qualified

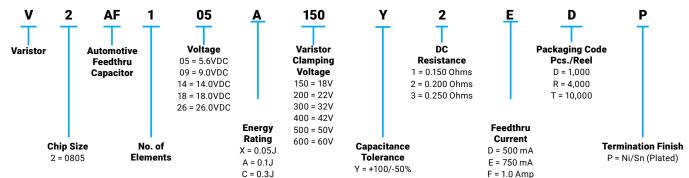




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#### **HOW TO ORDER**



## **TRANSFEED ELECTRICAL SPECIFICATIONS**

AVX Part Number	Working Voltage (DC)	Working Voltage (AC)	Breakdown Voltage	Clamping Voltage	Maximum Leakage Current	Transient Energy Rating	Peak Current Rating	Typical Cap	DC Resistance	Maximum Feedthru Current	Jump Start Voltage
V2AF105A150Y2E	5.6	4.0	8.5±20%	18	35	0.10	30	800	0.200	0.75	-
V2AF105C150Y1F	5.6	4.0	8.5±20%	18	35	0.30	120	2500	0.150	1.00	-
V2AF109A200Y2E	9.0	6.4	12.7±15%	22	25	0.10	30	575	0.200	0.75	-
V2AF109C200Y1F	9.0	6.4	12.7±15%	22	25	0.30	120	1800	0.150	1.00	-
V2AF114A300Y2E	14.0	10.0	18.5±12%	32	15	0.10	30	300	0.200	0.75	27.5
V2AF114C300Y1F	14.0	10.0	18.5±12%	32	15	0.30	120	900	0.150	1.00	27.5
V2AF118A400Y2E	18.0	13.0	25.5±10%	42	10	0.10	30	200	0.200	0.75	27.5
V2AF118C400Y1F	18.0	13.0	25.5±10%	42	10	0.30	120	500	0.150	1.00	27.5
V2AF118X500Y3D	18.0	13.0	25.5±10%	50	10	0.05	20	75	0.250	0.50	27.5
V2AF126C600Y2E	26.0	18.0	34.5±10%	60	10	0.3	80	250	0.2	0.75	27.5

 $V_{\text{JUMP}}$ 

│ └ Termination Finish Code

–Packaging Code

$V_w$ (DC)	DC Working Voltage (V)	Ε <sub>τ</sub>
V <sub>w</sub> (AC)	AC Working Voltage (V)	I <sub>P</sub>
V <sub>B</sub>	Typical Breakdown Voltage (V @ 1mA <sub>DC</sub> )	Сар
V <sub>B</sub> Tol	$V_{_{\rm B}}$ Tolerance is ± from Typical Value	DCR
V <sub>c</sub>	Clamping Voltage (V @ 1A 8x20µS )	I <sub>ft</sub>

IL Maximum Leakage Current at the Working Voltage (μA)

Transient Energy Rating (J, 10x1000µS)

Peak Current Rating (A, 8x20µS)

Typical Capacitance (pF) @ 1MHz and 0.5 V

DC Resistance (Ohms)

Maximum Feedthru Current (A)

Jump Start Voltage (V, 5 min)

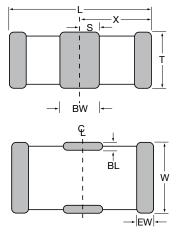


108

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### **DIMENSIONS**

		L	W	Т	BW	BL	EW	Х	S
08	15 1	.01 ± 0.20 079 ± 0.008)	1.25 ± 0.20 (0.049 ± 0.008)	1.143 Max. (0.045 Max.)	0.46 ± 0.10 (0.018 ± 0.004)	0.18 + 0.25 -0.08 (0.007 + 0.010 -0.003)	0.25 ± 0.13 (0.010 ± 0.005)	1.02 ± 0.10 (0.040 ± 0.004)	0.23 ± 0.05 (0.009 ± 0.002)

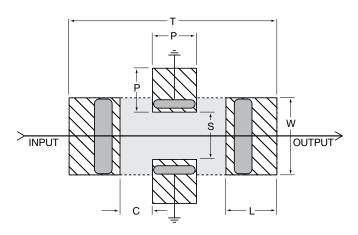


## **RECOMMENDED SOLDER PAD LAYOUT (TYPICAL DIMENSIONS)**

mm (inches)

[		Т	Р	S	W	L	С
	0805	3.45 (0.136)	0.51 (0.020)	0.76 (0.030)	1.27 (0.050)	1.02 (0.040)	0.46 (0.018)

#### 4 Pad Layout





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mm (inches)

## **AVX Multilayer Ceramic Transient Voltage Suppressors TVS Protection and EMI Attenuation in a Single Chip**

## **PERFORMANCE CHARACTERISTICS**

### **FEEDTHRU VARISTORS**

AVX Multilayer Feedthru Varistors (MLVF) are an ideal choice for system designers with transient strike and broadband EMI/RFI concerns.

Feedthru Varistors utilize a ZnO varistor material and the electrode pattern of a feedthru capacitor. This combination allows the package advantage of the feedthru and material advantages of the ZnO dielectric to be optimized. ZnO MLV Feedthrus exhibit electrical and physical advantages over standard ZnO MLVs. Among them are:

**Discrete MLV Model** 

To Device

Requiring

Protection

 $\geq$ 

- 1. Faster Turn on Time
- 2. Broadband EMI attenuation

PCB

Trace

>

3. Small size (relative to discrete MLV and EMI filter schemes)

The electrical model for a ZnO MLV and a ZnO Feedthru MLV are shown below. The key difference in the model for the Feedthru is a transformation in parallel to series inductance. The added series inductance helps lower the injected transient peak current (by  $2\pi$ fL) resulting in an additional benefit of a lower clamping voltage. The lowered parallel inductance decreases the turn on time for the varistor to <250ps.

- Solder Pad Solder Pad Lр С ξR<sub>P</sub> С Ron Ron I D Solder Pad Solder Pad Where. Voltage Variable resistance Where<sup>.</sup> Voltage Variable resistance R R. (per VI curve) (per VI curve)
  - $R_p \ge 1012 \Omega$
  - C = defined by voltage rating and energy level
  - R<sub>on</sub> = turn on resistance
  - L<sub>p</sub> = parallel body inductance

#### **Discrete MLVF Model**

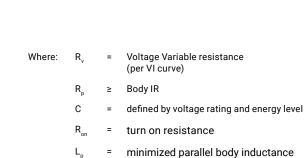
Ls

Ls

To Device

Requiring

Protection



series body inductance

L



Downloaded from Arrow.com.



## **AVX Multilayer Ceramic Transient Voltage Suppressors TVS Protection and EMI Attenuation in a Single Chip**



#### **PERFORMANCE CHARACTERISTICS**

#### **APPLICATIONS**

- EMI Suppression
- Broadband I/O Filtering
- Vcc Line Conditioning

#### **FEATURES**

- Small Size
- · Low ESR
- Ultra-fast Response Time
- · Broad S21 Characteristics

#### **MARKET SEGMENTS**

- Computers
- Automotive
- Power Supplies
- Multimedia Add-On Cards
- Bar Code Scanners
- Remote Terminals
- Medical Instrumentation
- Test Equipment
  Transceivers
- Transceivers
- Cellular Phones / Pagers

#### TYPICAL CIRCUITS REQUIRING TRANSIENT VOLTAGE PROTECTION AND EMI FILTERING

The following applications and schematic diagrams show where TransFeed $^{\oplus}$  TVS/ EMI filtering devices might be used:

- System Board Level Interfaces: (Fig. 1) Digital to RF Analog to Digital Digital to Analog
- Voltage Regulation (Fig. 2)
- Power Conversion Circuits (Fig. 3)
- CoAo EET Drotoction (Fig. 4)
- GaAs FET Protection (Fig. 4)

Fig. 1 - System Interface

#### **SPECIFICATION COMPARISON**

MLVF 0805		PARAMETER	MLV 0805	
5ph	Ls	typical	N/A	
<600nh	Lp	typical	<1.5nh	
<0.025Ω	Ron	typical	<0.1Ω	
100pf to 2.5nf	С	typical	100pf to 5.5nf	
see VI curves	Rv	typical	see VI curves	
>0.25 x 1012Ω <b>Rp</b> ty		typical	>1 x 1012Ω	
<250ps		pical turn on time Il frequency response	<500ps	

A comparison table showing typical element parameters and resulting performance features for MLV and MLVF is shown above.

Fig. 2 – Voltage Regulators

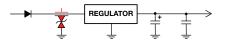
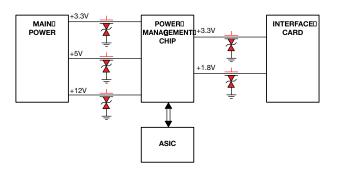
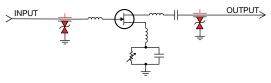


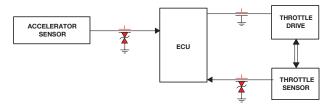
Fig. 3 – Power Conversion Circuits/Power Switching Circuits



#### Fig. 4 – GaAs FET Protection



#### Fig. 5 – Automotive TransFeed - Throttle by Wire





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